503.39864X00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

expplicant(s)

licant(s): Toshiya SATOH et al.

Serial No.:

09/809,181

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March 16, 2001

For:

SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD

THEREOF

Group:

2815

<u>INFORMATION DISCLOSURE STATEMENT</u> <u>UNDER 37 CFR §1.97 & §1.98</u>

Assistant-Commissioner-of-Patents Washington, D.C. 20231

March-27, 2002

Sir:

In the matter of the above-identified application, Applicants are submitting herewith a copy of the document listed in the attached form equivalent to Form PTO-1449 for the Examiner's consideration.

This information disclosure statement is being submitted before the mailing date of either a final action or a notice of allowance, and is accompanied by the following certification specified in 37 CFR §1.97(e):

On information and belief, Applicants hereby certify that each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.

(c1) Each of the documents listed on the attached form equivalent to Form PTO-1449 is in the English language. (c2) To the extent the documents listed on the attached form equivalent to Form PTO-1449 are not in the English language, the requirement of 37 CFR §1.98(a)(3) for a concise explanation of the relevance is satisfied by the Abstract.

It is respectfully requested that this information disclosure statement be considered by the Examiner.

Please charge any shortage in the fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account No. 01-2135 (503.39864X00) and please credit any excess fees to such deposit account.

Respectfully submitted,

Hung H. Bui

Registration No. 40,415

ANTONELLI, TERRY, STOUT & KRAUS, LLP

HHB/srm Attachments (703) 312-6600